

AOD609-VB Datasheet

N- and P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY

	N-CHANNEL	P-CHANNEL
V_{DS} (V)	40	- 40
$R_{DS(on)}$ (Ω) at $V_{GS} = \pm 10$ V	0.014	0.014
$R_{DS(on)}$ (Ω) at $V_{GS} = \pm 4.5$ V	0.016	0.016
I_D (A)	50	- 50
Configuration	N- and P-Pair	

FEATURES

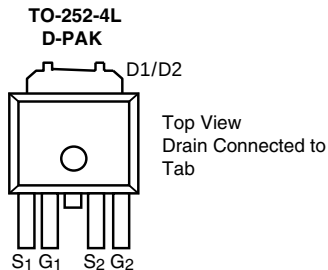
- Trench Power MOSFET
- 100 % R_g and UIS Tested

APPLICATIONS

- CCFL Inverter



RoHS
COMPLIANT
HALOGEN
FREE



ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise noted)

PARAMETER		SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Drain-Source Voltage		V _{DS}	40	- 40	V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current ^a	T _C = 25 °C	I _D	50	-50	A
	T _C = 125 °C		35	-35	
Continuous Source Current (Diode Conduction) ^a		I _S	50	-50	
Pulsed Drain Current ^b		I _{DM}	150	-150	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	30	- 30	mJ
Single Pulse Avalanche Energy		E _{AS}	245	245	
Maximum Power Dissipation ^b	T _C = 25 °C	P _D	108	108	W
	T _C = 125 °C		32	32	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175		°C
Soldering Recommendations (Peak Temperature)			260		

THERMAL RESISTANCE RATINGS

PARAMETER	SYMBOL	N-CHANNEL	P-CHANNEL	UNIT
Junction-to-Ambient	R_{thJA}	85	85	$^\circ\text{C/W}$
Junction-to-Case (Drain)	R_{thJC}	3.1	3.1	

Notes

- Package limited.
- Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- When mounted on 1" square PCB (FR4 material).
- Parametric verification ongoing.

SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)									
PARAMETER	SYMBOL	TEST CONDITIONS			MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		N-Ch	40	-	-	V	
		V _{GS} = 0 V, I _D = - 250 μA		P-Ch	- 40	-	-		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA		N-Ch	1.0	-	3.0		
		V _{DS} = V _{GS} , I _D = - 250 μA		P-Ch	- 1.0	-	-3.0		
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V		N-Ch	-	-	± 100	nA	
				P-Ch	-	-	± 100		
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 40 V	N-Ch	-	-	1	μA	
		V _{GS} = 0 V	V _{DS} = - 40 V	P-Ch	-	-	- 1		
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 125 °C	N-Ch	-	-	50		
		V _{GS} = 0 V	V _{DS} = - 40 V, T _J = 125 °C	P-Ch	-	-	- 50		
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	N-Ch	-	-	150		
		V _{GS} = 0 V	V _{DS} = - 40 V, T _J = 175 °C	P-Ch	-	-	- 150		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	V _{DS} ≥ 5 V	N-Ch	25	-	-	A	
		V _{GS} = - 10 V	V _{DS} ≤ 5 V	P-Ch	- 25	-	-		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 38 A	N-Ch	-	0.014	-	Ω	
		V _{GS} = - 10 V	I _D = - 38 A	P-Ch	-	0.014	-		
		V _{GS} = 10 V	I _D = 38 A, T _J = 125 °C	N-Ch	-	0.017	-		
		V _{GS} = - 10 V	I _D = - 38 A, T _J = 125 °C	P-Ch	-	0.017	-		
		V _{GS} = 10 V	I _D = 38 A, T _J = 175 °C	N-Ch	-	0.025	-		
		V _{GS} = - 10 V	I _D = - 38 A, T _J = 175 °C	P-Ch	-	0.025	-		
		V _{GS} = 4.5 V	I _D = 30 A	N-Ch	-	0.016	-		
		V _{GS} = - 4.5 V	I _D = - 30A	P-Ch	-	0.016	-		
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 38 A		N-Ch	-	40	-	S	
		V _{DS} = - 15 V, I _D = - 38 A		P-Ch	-	18	-		
Dynamic ^b									
Input Capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch	-	1799	2248	pF	
		V _{GS} = 0 V	V _{DS} = - 20 V, f = 1 MHz	P-Ch	-	2000	3500		
Output Capacitance	C _{oss}	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch	-	282	352		
		V _{GS} = 0 V	V _{DS} = - 20 V, f = 1 MHz	P-Ch	-	320	550		
Reverse Transfer Capacitance	C _{rss}	V _{GS} = 0 V	V _{DS} = 20 V, f = 1 MHz	N-Ch	-	109	136		
		V _{GS} = 0 V	V _{DS} = - 20 V, f = 1 MHz	P-Ch	-	220	360		
Total Gate Charge ^c	Q _g	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 10 A	N-Ch	-	310	-	nC	
		V _{GS} = - 10 V	V _{DS} = - 20 V, I _D = - 10 A	P-Ch	-	420	-		
Gate-Source Charge ^c	Q _{gs}	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 10 A	N-Ch	-	5.7	-		
		V _{GS} = - 10 V	V _{DS} = - 20 V, I _D = - 10 A	P-Ch	-	5.5	-		
Gate-Drain Charge ^c	Q _{gd}	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 10 A	N-Ch	-	4.8	-		
		V _{GS} = - 10 V	V _{DS} = - 20 V, I _D = - 10 A	P-Ch	-	10.5	-		
Gate Resistance	R _g	f = 1 MHz			N-Ch	2	4.11	6.2	Ω
					P-Ch	3.1	6.3	9.5	

Notes

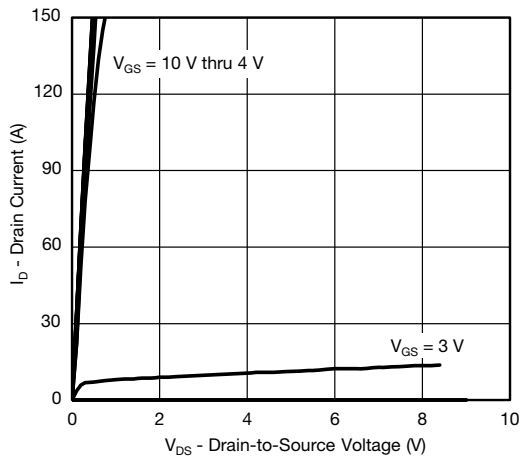
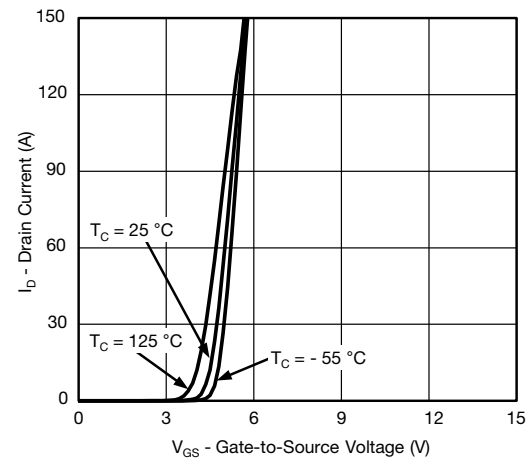
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.
 c. Independent of operating temperature.

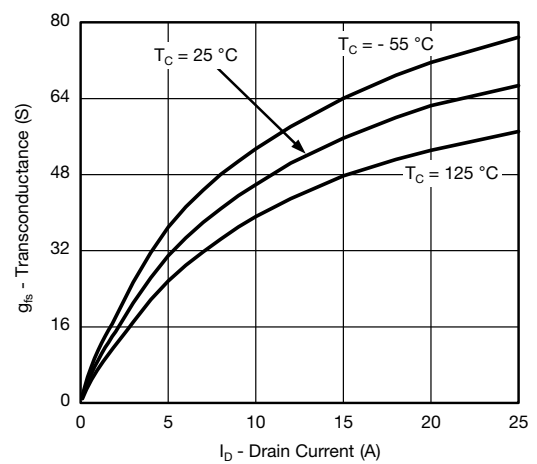
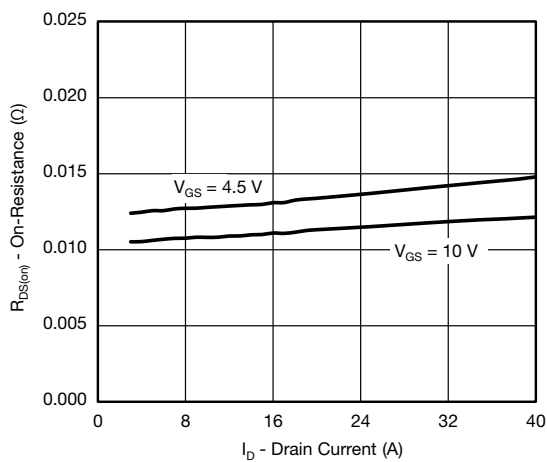
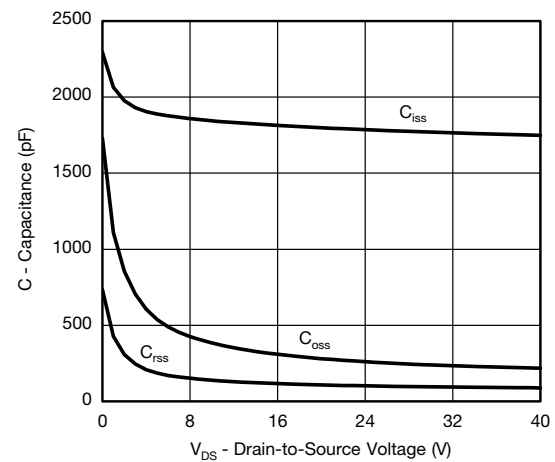
SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 20 V, R _L = 2 Ω I _D ≅ 10 A, V _{GEN} = 10 V, R _g = 1 Ω	N-Ch	-	7	11	ns
		V _{DD} = - 20 V, R _L = 2 Ω I _D ≅ - 10 A, V _{GEN} = - 10 V, R _g = 1 Ω	P-Ch	-	11	17	
Rise Time ^c	t _r	V _{DD} = 20 V, R _L = 2 Ω I _D ≅ 10 A, V _{GEN} = 10 V, R _g = 1 Ω	N-Ch	-	21	32	
		V _{DD} = - 20 V, R _L = 2 Ω I _D ≅ - 10 A, V _{GEN} = - 10 V, R _g = 1 Ω	P-Ch	-	9	14	
Turn-Off Delay Time ^c	t _{d(off)}	V _{DD} = 20 V, R _L = 2 Ω I _D ≅ 10 A, V _{GEN} = 10 V, R _g = 1 Ω	N-Ch	-	33	50	
		V _{DD} = - 20 V, R _L = 2 Ω I _D ≅ - 10 A, V _{GEN} = - 10 V, R _g = 1 Ω	P-Ch	-	55	83	
Fall Time ^c	t _f	V _{DD} = 20 V, R _L = 2 Ω I _D ≅ 10 A, V _{GEN} = 10 V, R _g = 1 Ω	N-Ch	-	19	29	
		V _{DD} = - 20 V, R _L = 2 Ω I _D ≅ - 10 A, V _{GEN} = - 10 V, R _g = 1 Ω	P-Ch	-	91	137	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed Current ^a	I _{SM}		N-Ch	-	-	32	A
			P-Ch	-	-	- 32	
Forward Voltage	V _{SD}	I _S = 4 A	N-Ch	-	0.79	1.2	V
		I _S = - 4 A	P-Ch	-	- 0.82	- 1.2	

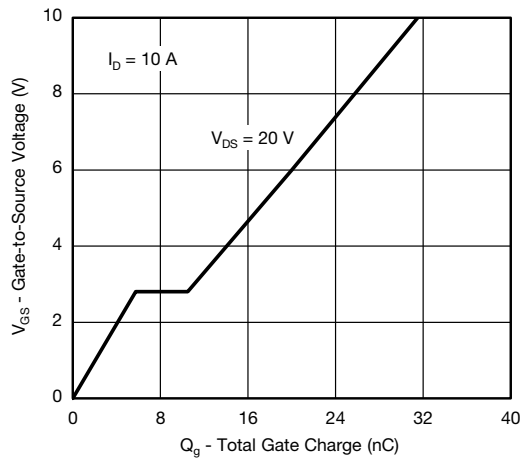
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.
 c. Independent of operating temperature.

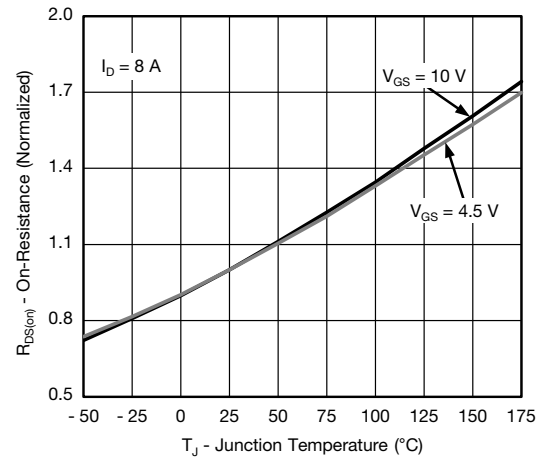
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Output Characteristics

Transfer Characteristics

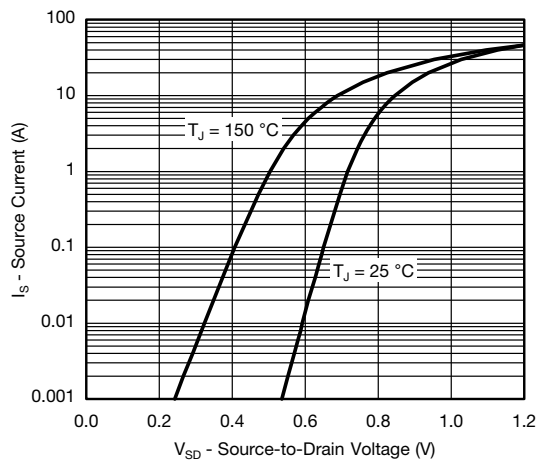
Transfer Characteristics

Transconductance

On-Resistance vs. Drain Current

Capacitance

N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)


Gate Charge



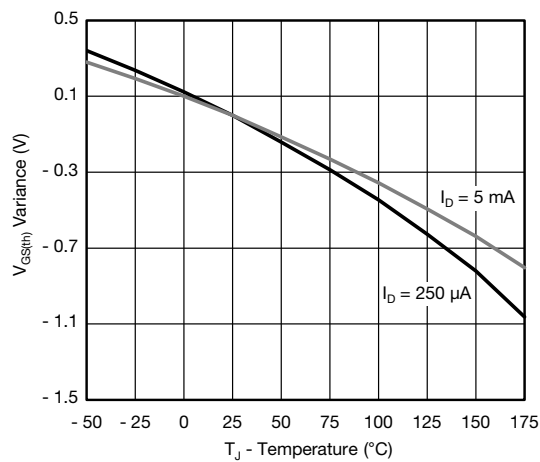
On-Resistance vs. Junction Temperature



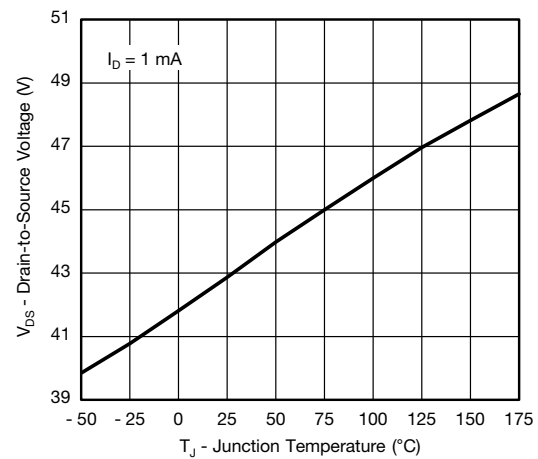
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Drain Source Breakdown vs. Junction Temperature

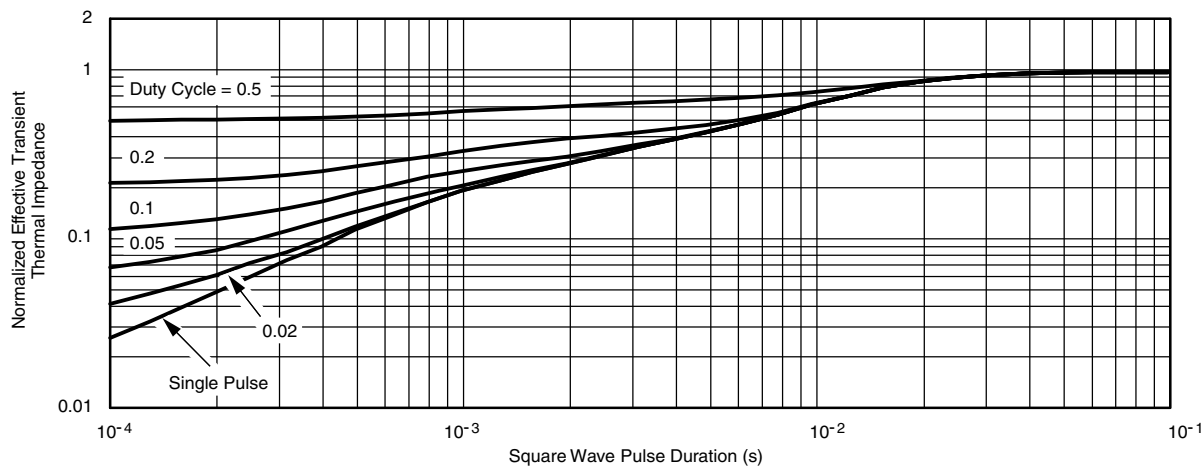
N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



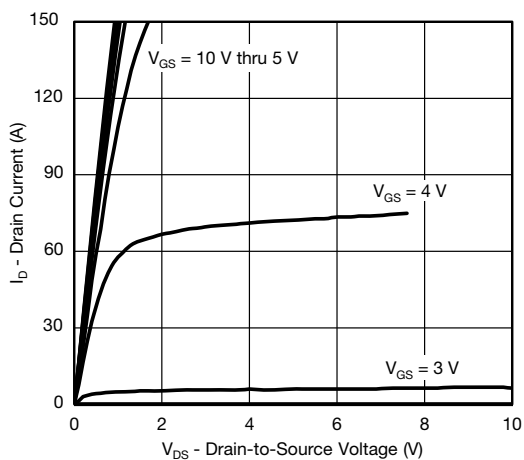
Safe Operating Area



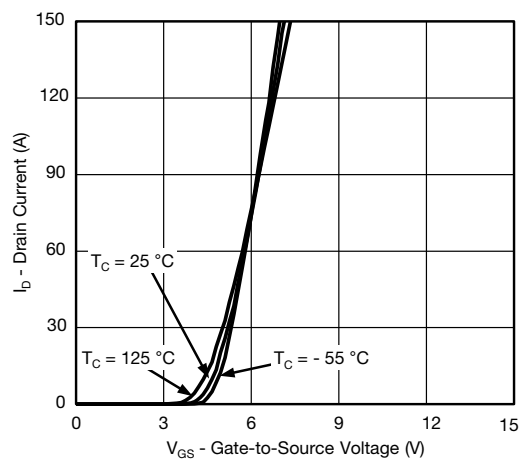
Normalized Thermal Transient Impedance, Junction-to-Ambient

N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Case
Note

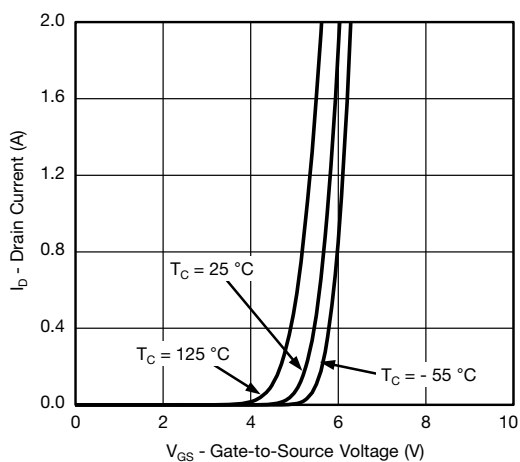
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient ($25\text{ }^{\circ}\text{C}$)
 - Normalized Transient Thermal Impedance Junction-to-Case ($25\text{ }^{\circ}\text{C}$)
 are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)


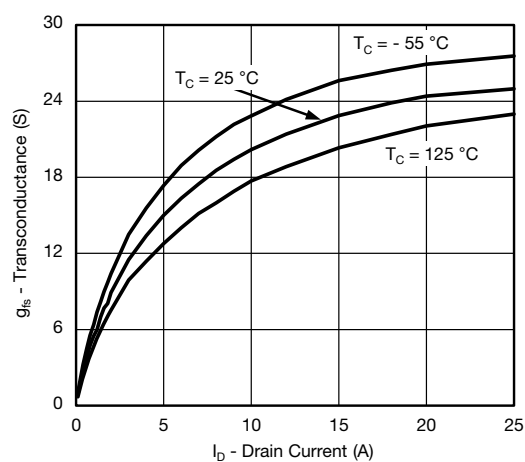
Output Characteristics



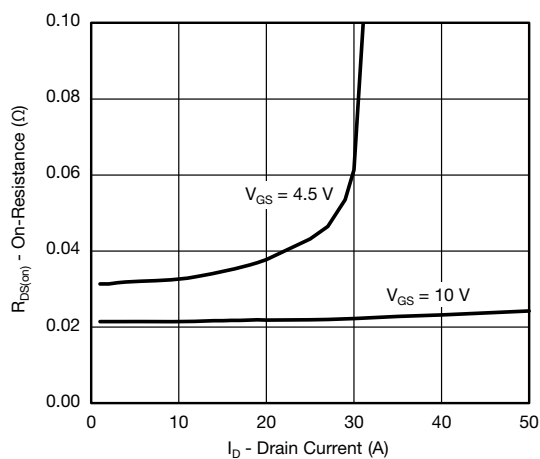
Transfer Characteristics



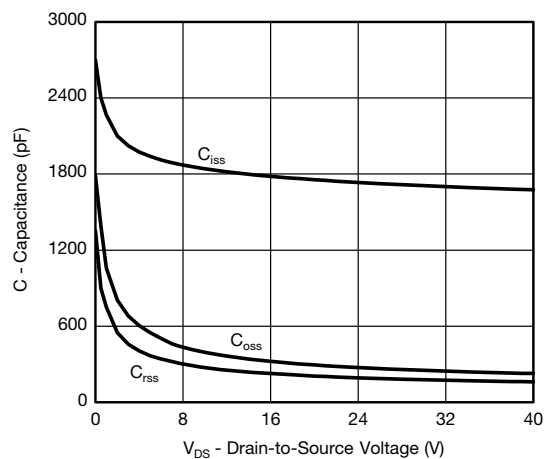
Transfer Characteristics



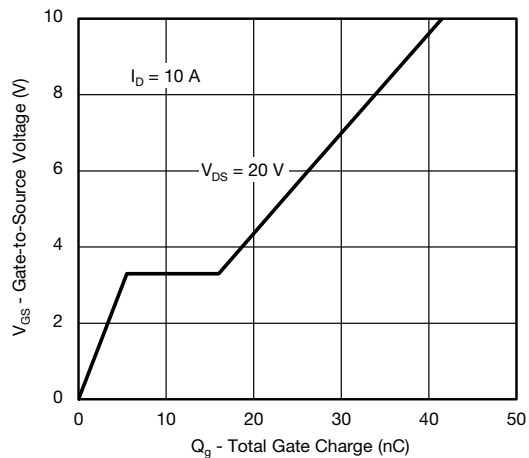
Transconductance



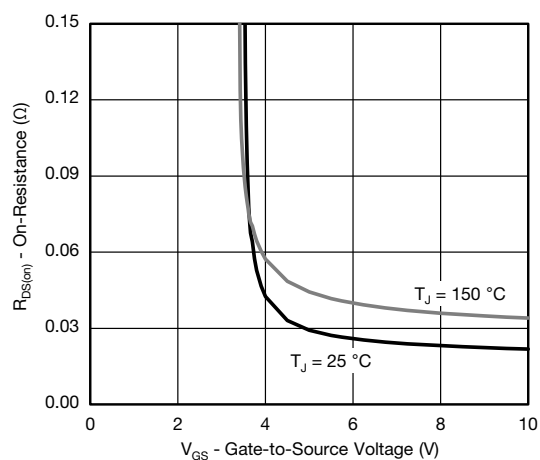
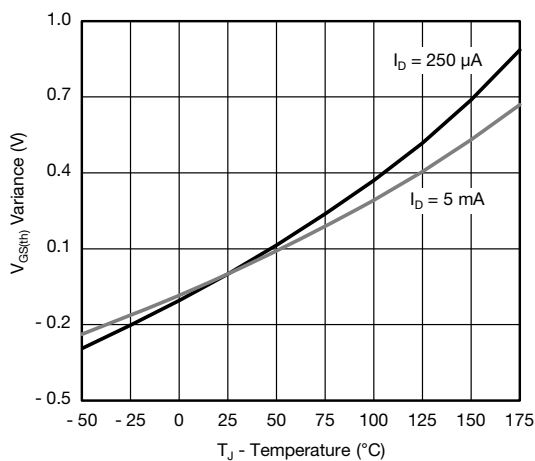
On-Resistance vs. Drain Current



Capacitance

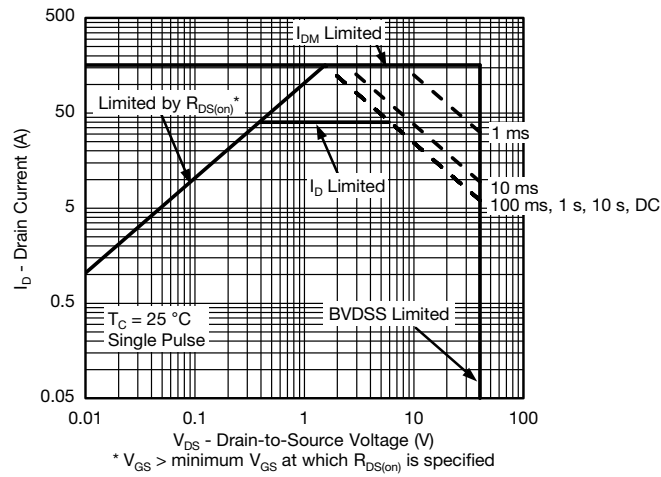
P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Gate Charge

On-Resistance vs. Junction Temperature

Source Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Drain Source Breakdown vs. Junction Temperature

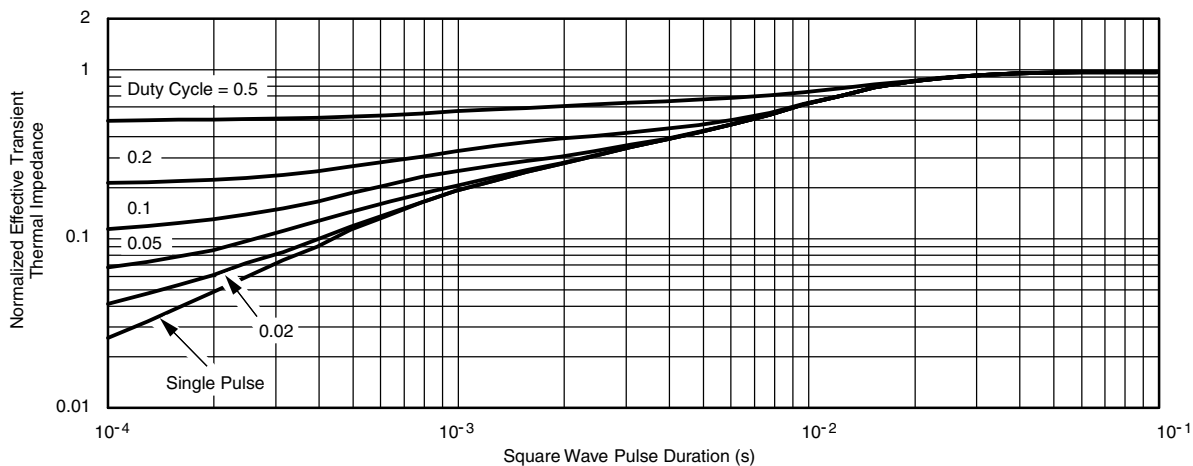
P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Normalized Thermal Transient Impedance, Junction-to-Case
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient ($25\text{ }^{\circ}\text{C}$)
 - Normalized Transient Thermal Impedance Junction-to-Case ($25\text{ }^{\circ}\text{C}$)
 are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

TO-252_4L Package Outline



RECOMMENDED LAND PATTERN



- NOTE
1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS. MOLD FLASH SHOULD BE LESS THAN 6 MIL.
 2. DIMENSION L IS MEASURED IN GAUGE PLANE.
 3. TOLERANCE 0.10 mm UNLESS OTHERWISE SPECIFIED.
 4. CONTROLLING DIMENSION IS MILLIMETER. CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.
 5. REFER TO JEDEC TO-252 (AD).

SYMBOL	DIMENSION IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	2.184	2.286	2.388	0.086	0.090	0.094
A1	0.000	----	0.127	0.000	----	0.005
A2	0.889	----	1.143	0.035	----	0.045
b	0.508	----	0.711	0.020	----	0.028
b1	0.584	----	0.787	0.023	----	0.031
b2	4.953	----	5.461	0.195	----	0.215
c	0.457	0.508	0.610	0.018	0.020	0.024
c1	0.457	----	0.610	0.018	----	0.024
D	5.969	6.096	6.223	0.235	0.240	0.245
E	6.350	6.604	6.731	0.250	0.260	0.265
e	1.270 BSC.			0.050 BSC.		
H	9.398	----	10.414	0.370	----	0.410
L	1.270	----	2.032	0.050	----	0.080
L1	----	----	1.016	----	----	0.040
L2	0.889	----	1.270	0.035	----	0.050

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